

Philips Semiconductors

Product specification

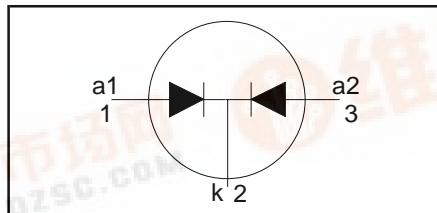
Rectifier diodes
Schottky barrier

PBYR2545CT, PBYR2545CTB series

FEATURES

- Low forward volt drop
- Fast switching
- Reverse surge capability
- High thermal cycling performance
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

$V_R = 40 \text{ V} / 45 \text{ V}$
$I_{O(AV)} = 30 \text{ A}$
$V_F \leq 0.62 \text{ V}$

GENERAL DESCRIPTION

Dual, common cathode schottky rectifier diodes in a conventional leaded plastic package and a surface mounting plastic package. Intended for use as output rectifiers in low voltage, high frequency switched mode power supplies.

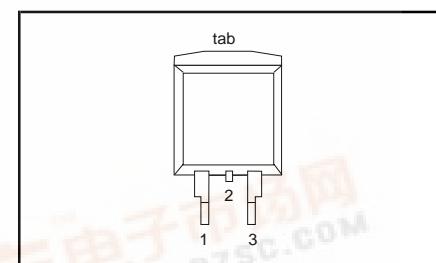
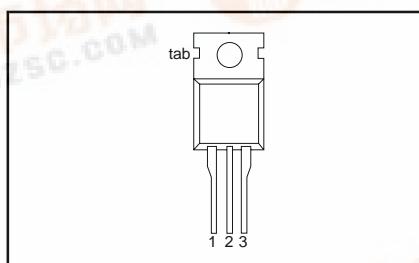
The PBYR2545CT series is supplied in the SOT78 conventional leaded package. The PBYR2545CTB series is supplied in the SOT404 surface mounting package.

PINNING

SOT78 (TO220AB)

SOT404

PIN	DESCRIPTION
1	anode 1 (a)
2	cathode (k) ¹
3	anode 2 (a)
tab	cathode (k)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V_{RRM}	Peak repetitive reverse voltage	PBYR25 PBYR25	-	40CT 40CTB	40	V
V_{RWM}	Working peak reverse voltage		-	40	45	V
V_R	Continuous reverse voltage	$T_{mb} \leq 113 \text{ }^\circ\text{C}$	-	40	45	V
$I_{O(AV)}$	Average rectified forward current (both diodes conducting) ²	square wave; $\delta = 0.5$; $T_{mb} \leq 126 \text{ }^\circ\text{C}$	-	30		A
I_{FRM}	Repetitive peak forward current per diode	square wave; $\delta = 0.5$; $T_{mb} \leq 126 \text{ }^\circ\text{C}$	-	30		A
I_{FSM}	Non-repetitive peak forward current per diode	$t = 10 \text{ ms}$ $t = 8.3 \text{ ms}$ sinusoidal; $T_j = 125 \text{ }^\circ\text{C}$ prior to surge; with reapply $V_{RRM(max)}$ pulse width and repetition rate limited by $T_{j\max}$	-	180	200	A
I_{RRM}	Peak repetitive reverse surge current per diode		-	1		A
T_j	Operating junction temperature		-	150		$^\circ\text{C}$
T_{stg}	Storage temperature		-65	175		$^\circ\text{C}$

1. It is not possible to make connection to pin 2 of the SOT404 package.

2. SOT78 package. For output currents greater than 20A the cathode connection should be made to the metal mounting tab.

Rectifier diodes
Schottky barrier

PBYR2545CT, PBYR2545CTB series

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j\text{-}mb}$	Thermal resistance junction to mounting base	per diode	-	-	1.5	K/W
$R_{th\ j\text{-}a}$	Thermal resistance junction to ambient	both diodes SOT78 package in free air SOT404 package, pcb mounted, minimum footprint, FR4 board	- - - -	- 60 50	1 - -	K/W K/W K/W K/W

ELECTRICAL CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	Forward voltage per diode	$I_F = 20\text{ A}; T_j = 125^\circ\text{C}$ $I_F = 30\text{ A}; T_j = 125^\circ\text{C}$ $I_F = 30\text{ A}$	- - -	0.58 0.72 0.72	0.62 0.76 0.82	V V V
I_R	Reverse current per diode	$V_R = V_{RWM}$ $V_R = V_{RWM}; T_j = 100^\circ\text{C}$	-	0.3	2	mA
C_d	Junction capacitance per diode	$V_R = 5\text{ V}; f = 1\text{ MHz}, T_j = 25^\circ\text{C to } 125^\circ\text{C}$	-	30 530	40 -	mA pF

Rectifier diodes Schottky barrier

PBYR2545CT, PBYR2545CTB series

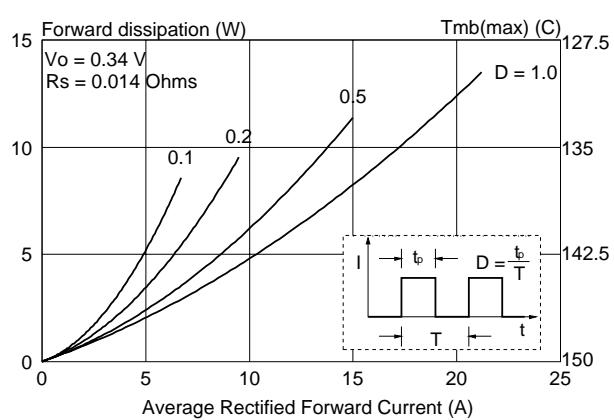


Fig.1. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where
 $I_{F(AV)} = I_{F(\text{RMS})} \times \sqrt{D}$.

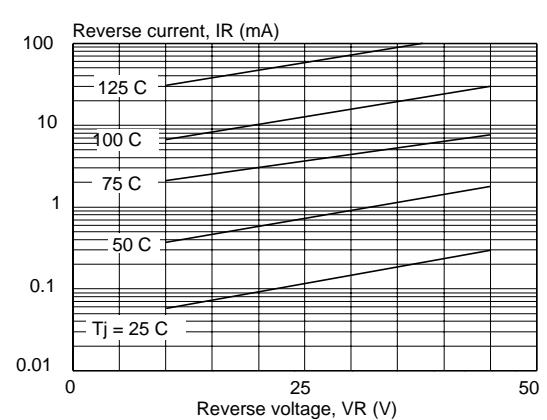


Fig.4. Typical reverse leakage current per diode;
 $I_R = f(V_R)$; parameter T_j

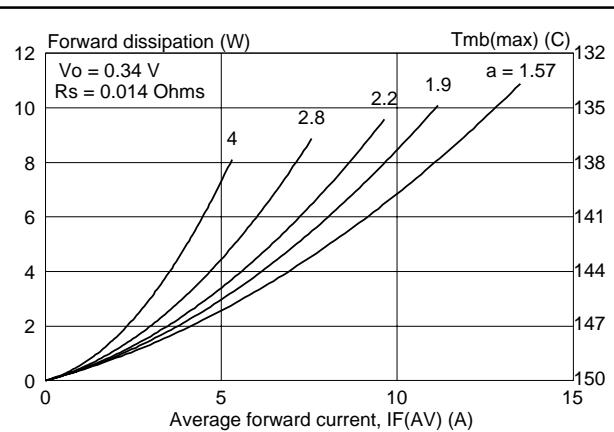


Fig.2. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where $a = \text{form factor} = I_{F(\text{RMS})} / I_{F(AV)}$.

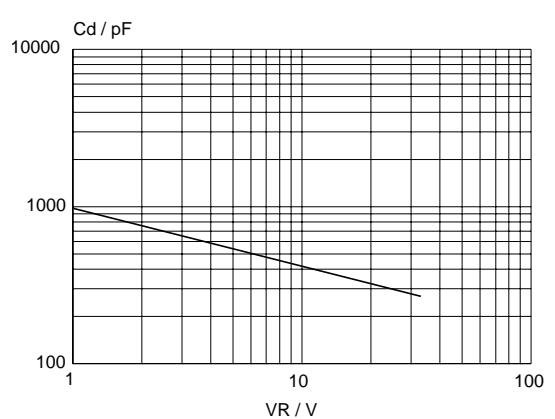


Fig.5. Typical junction capacitance per diode;
 $C_d = f(V_R)$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$ to $125 \text{ }^\circ\text{C}$.

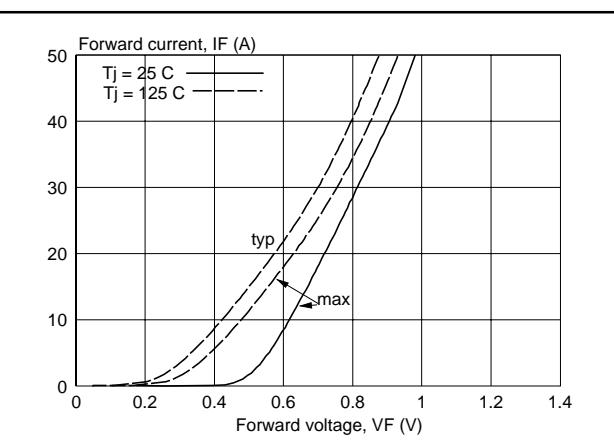


Fig.3. Typical and maximum forward characteristic
 $I_F = f(V_F)$; parameter T_j

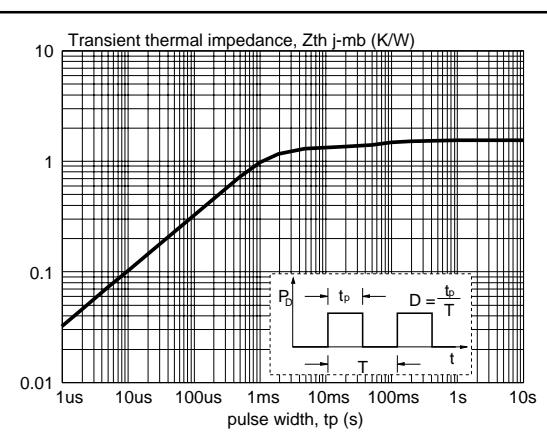


Fig.6. Transient thermal impedance per diode;
 $Z_{th \text{ j-mb}} = f(t_p)$.

Rectifier diodes
Schottky barrier

PBYR2545CT, PBYR2545CTB series

MECHANICAL DATA

Dimensions in mm

Net Mass: 2 g

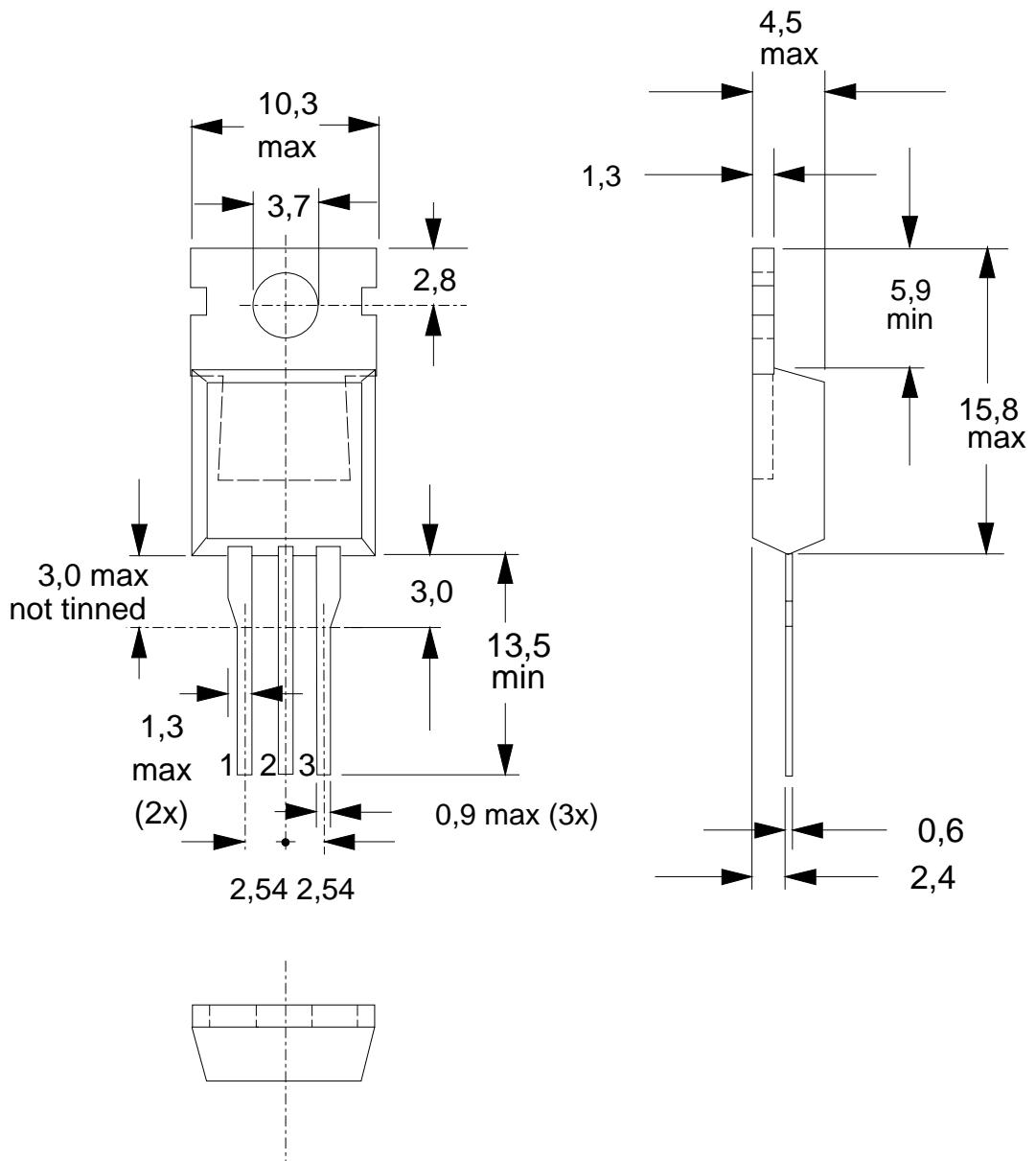


Fig.7. SOT78 (TO220AB); pin 2 connected to mounting base.

Notes

1. Refer to mounting instructions for SOT78 (TO220) envelopes.
2. Epoxy meets UL94 V0 at 1/8".

Rectifier diodes
Schottky barrier

PBYR2545CT, PBYR2545CTB series

MECHANICAL DATA

Dimensions in mm

Net Mass: 1.4 g

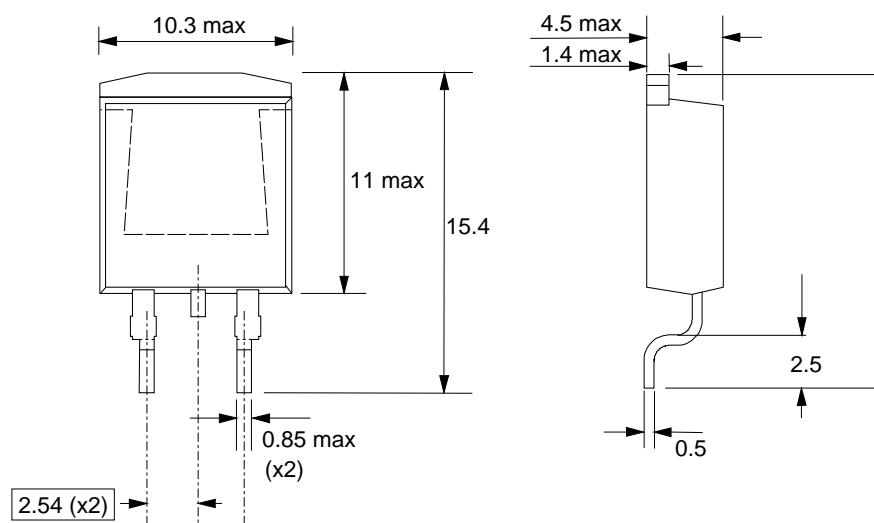


Fig.8. SOT404 : centre pin connected to mounting base.

MOUNTING INSTRUCTIONS

Dimensions in mm

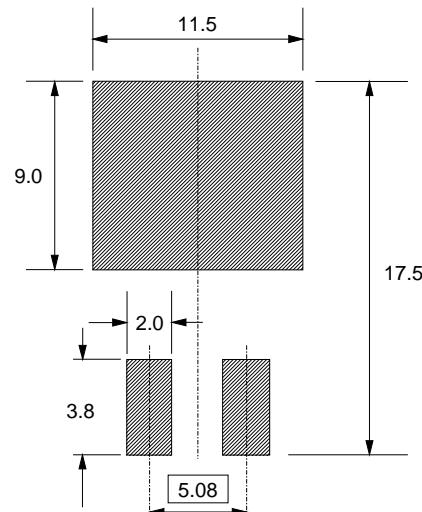


Fig.9. SOT404 : soldering pattern for surface mounting.

Notes

1. Epoxy meets UL94 V0 at 1/8".

Rectifier diodes
Schottky barrier

PBYR2545CT, PBYR2545CTB series

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
© Philips Electronics N.V. 1998	
All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.	
The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.